

● Description

The KTLP260J series consist of a GaAs infrared emitting diode optically coupled to a non-zero-crossing silicon bilateral AC switch (TRIAC). These devices isolate low voltage logic from 115/240 VAC lines to provide random phase control of high current TRIACs or thyristors. These devices feature greatly enhanced static dv/dt capability to ensure stable switching performance of inductive loads.

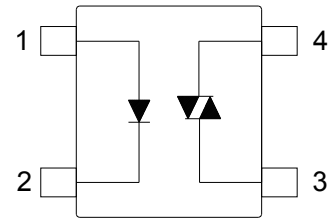
● Features

1. Pb free and RoHS compliant
2. 600V peak blocking voltage
3. Subminiature type (The volume is smaller than that of our conventional DIP type by as far as 30%)
4. Simplifies logic control of 115/240 VAC power
5. Non zero voltage crossing
6. Isolation voltage between input and output (Viso : 3750Vms)
7. MSL class 1
8. Agency Approvals :
 - UL Approved (No. E169586): UL1577
 - C-UL Approved (No. E169586)
 - VDE Approved (No. 40009235): DIN EN60747-5-5
 - CQC Approved: GB8898-2011, GB4943.1-2011

● Applications

- Solenoid/Valve controls
- Lighting controls
- Static power switches
- AC motor drives
- Temperature controls
- E.M contactors
- AC motor contactors
- Solid state relay
- Programmable controllers

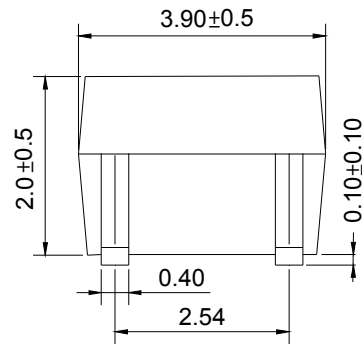
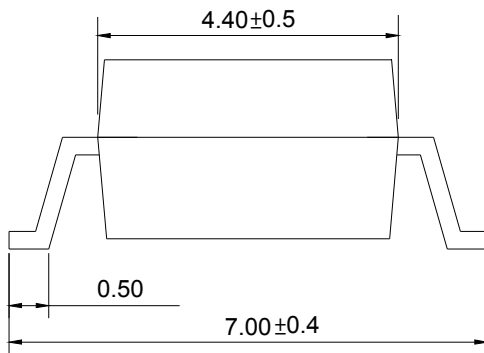
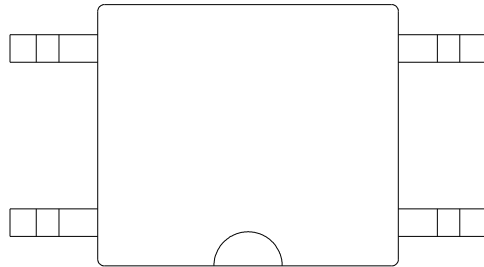
● Schematic



1. Anode
2. Cathode
3. Main terminal
4. Main terminal

● **Outside Dimension**

Unit : mm



TOLERANCE : ±0.2mm

● **Device Marking**



Notes :

COSMO

260J

YWW

Y : Year code / W : Week code

● Absolute Maximum Ratings

(Ta=25°C)

| Parameter | | Symbol | Rating | Unit |
|----------------------------------|--|--------------|-------------|------------|
| Input | Forward current | I_F | 50 | mA |
| | Peak forward current | I_{FM} | 1 | A |
| | Reverse voltage | V_R | 6 | V |
| | Power dissipation | P_D | 70 | mW |
| Output | Off-state output terminal voltage | V_{DRM} | 600 | V_{PEAK} |
| | On-state R.M.S. current | $I_{T(RMS)}$ | 70 | mA |
| | Peak repetitive surge current (PW=10ms.DC 10%) | I_{TSM} | 1 | A |
| | Power dissipation | P_D | 150 | mW |
| Total power dissipation | | P_{tot} | 200 | mW |
| Isolation voltage 1 minute | | V_{iso} | 3750 | Vrms |
| Operating temperature | | T_{opr} | -40 to +115 | °C |
| Storage temperature | | T_{stg} | -50 to +125 | °C |
| Soldering temperature 10 seconds | | T_{sol} | 260 | °C |

● Electro-optical Characteristics

(Ta=25°C)

| Parameter | | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|--------------------------|--|-----------|-------------------------------------|--------------------|-----------|------|------------|
| Input | Forward voltage | V_F | $I_F=10mA$ | - | 1.2 | 1.4 | V |
| | Reverse current | I_R | $V_R=4V$ | - | - | 10 | μA |
| Output | Peak blocking current | I_{DRM} | V_{DRM} Rated | - | - | 1 | μA |
| | On-state voltage | V_{TM} | $I_{TM}=70mA$ | - | 1.6 | 3 | V |
| Transfer characteristics | Holding current | I_H | | - | 0.1 | - | mA |
| | Critical rate of rise of off-state voltage | dv/dt | $V_{DRM}=(1/\sqrt{2})*\text{Rated}$ | 1000 | - | - | V/ μs |
| | Isolation resistance | R_{iso} | DC500V | 5×10^{10} | 10^{11} | - | Ω |
| | Minimum trigger current | I_{FT} | Main terminal voltage=3V | - | - | 10 | mA |
| | Turn-on time | T_{on} | $V_D=6V, R_L=100\Omega, I_F=20mA$ | - | - | 100 | μs |

● Static dv/dt Test Circuit

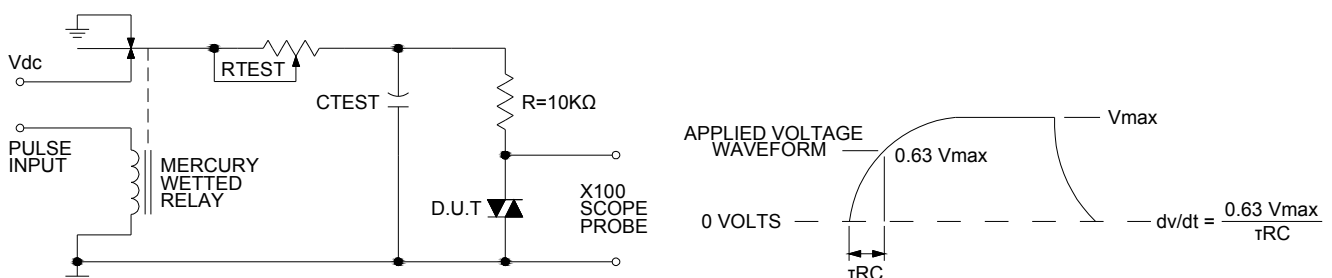


Fig.1 Forward Current I_F vs. Ambient Temperature

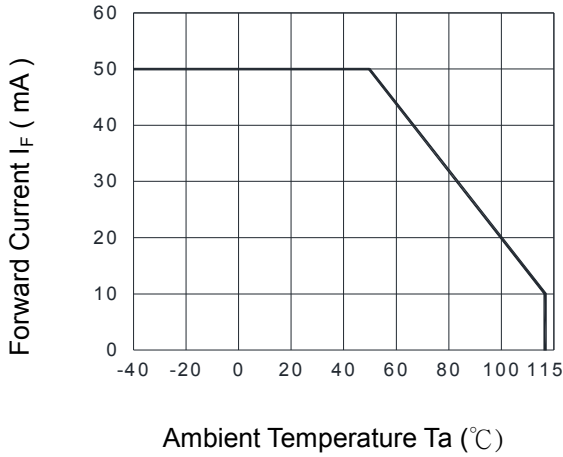


Fig.2 Diode Power Dissipation P_D vs. Ambient Temperature

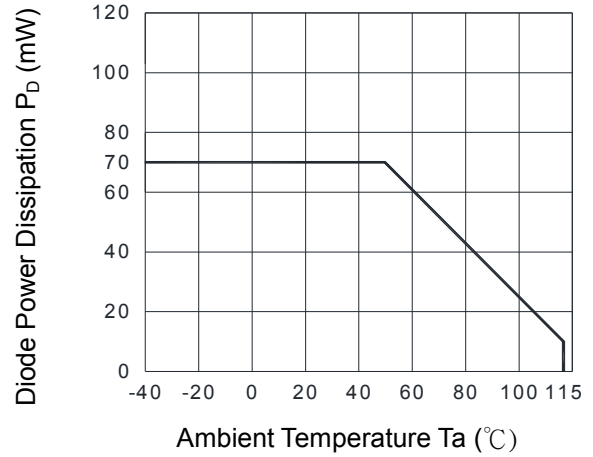


Fig.3 On-state R.M.S. Current I_{TM} vs. Ambient Temperature

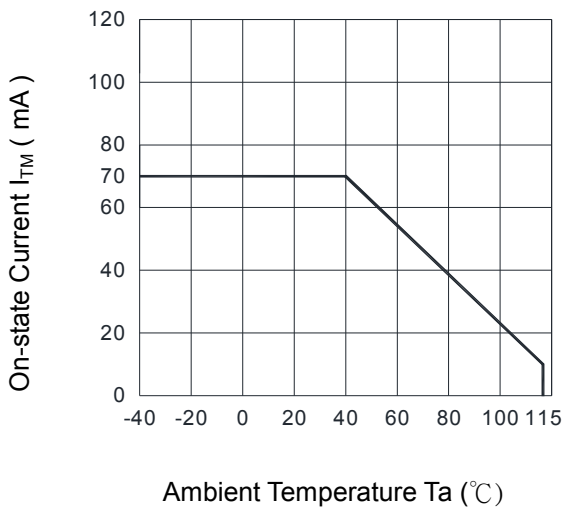


Fig.4 Total Power Dissipation P_D vs. Ambient Temperature

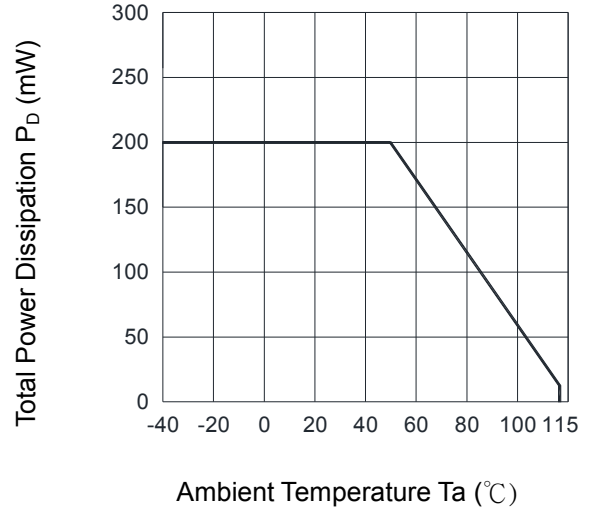


Fig.5 Peak Forward Current I_{FT} vs. Duty Ratio

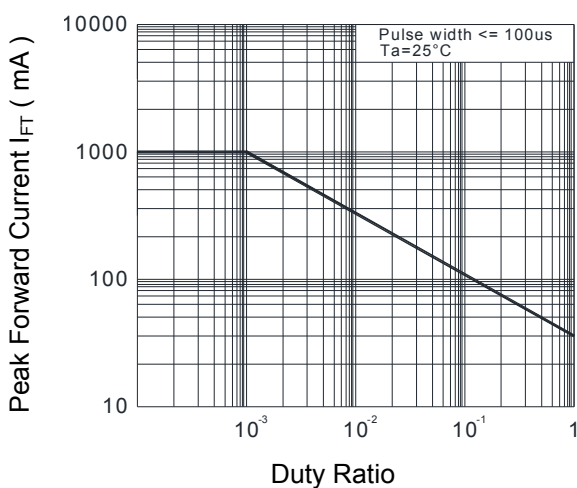


Fig.6 Forward Current I_F vs. Forward Voltage

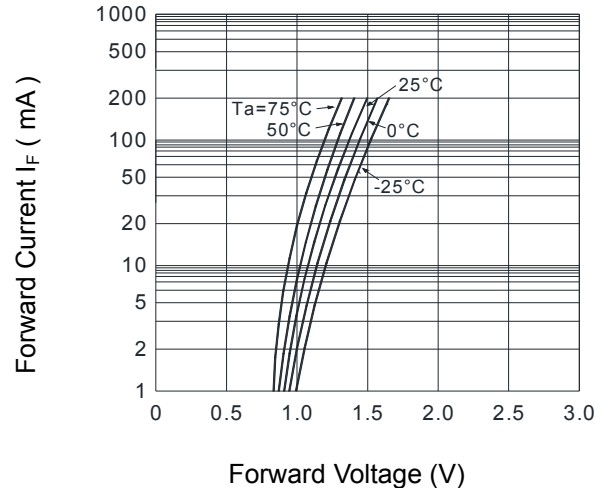
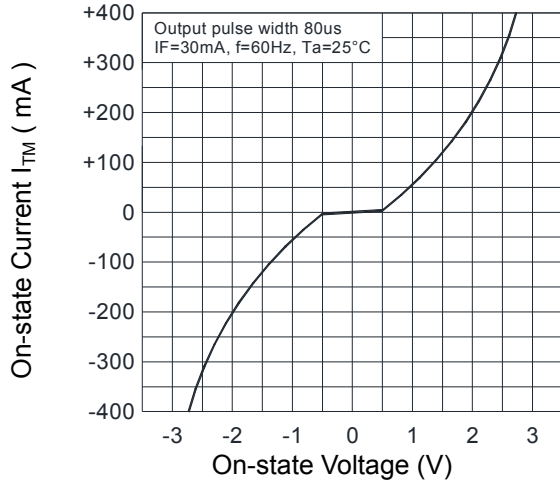
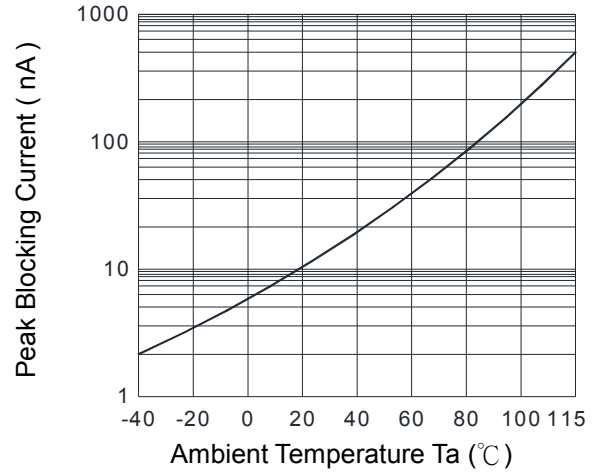
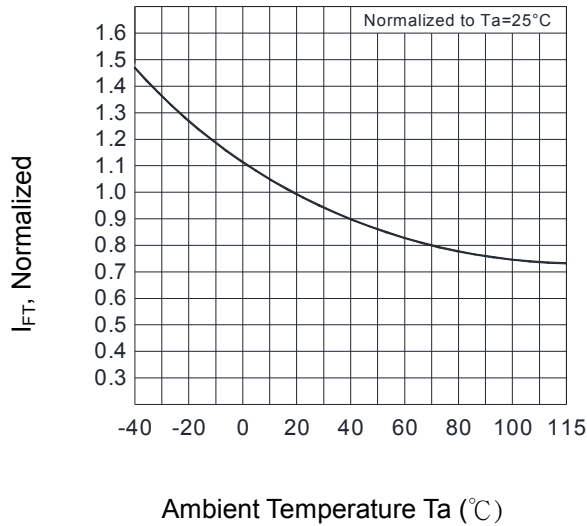


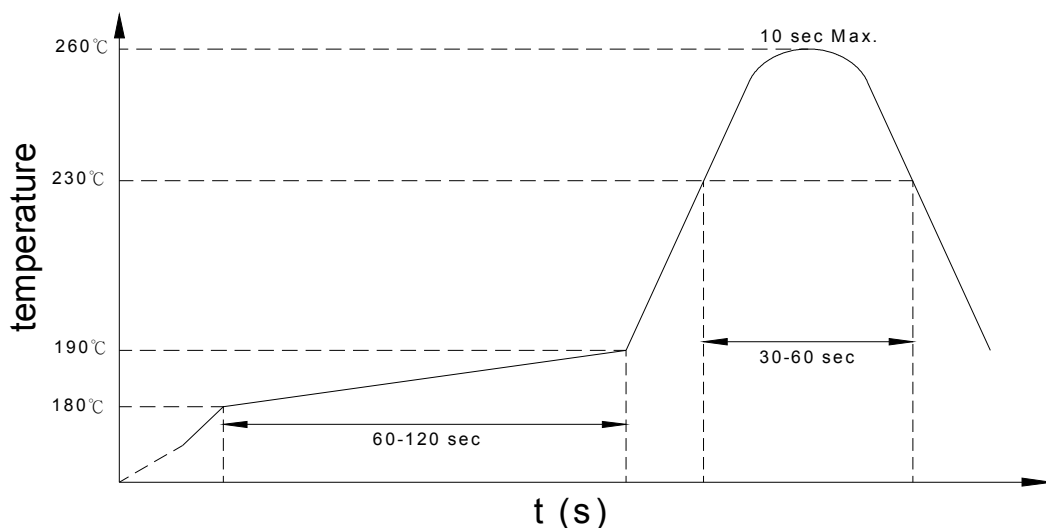
Fig.7 On-state Characteristics

Fig.8 Leakage with LED off vs. Ambient Temperature

Fig.9 Trigger Current vs. Ambient Temperature


● Recommended Soldering Conditions

(a) Infrared reflow soldering :

- Peak reflow soldering : 260°C or below (package surface temperature)
- Time of peak reflow temperature : 10 sec
- Time of temperature higher than 230°C : 30-60 sec
- Time to preheat temperature from 180~190°C : 60-120 sec
- Time(s) of reflow : Two
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering :

- Temperature : 260°C or below (molten solder temperature)
- Time : 10 seconds or less
- Preheating conditions : 120°C or below (package surface temperature)
- Time(s) of reflow : One
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.

- **Numbering System**

KTLP260J (X)

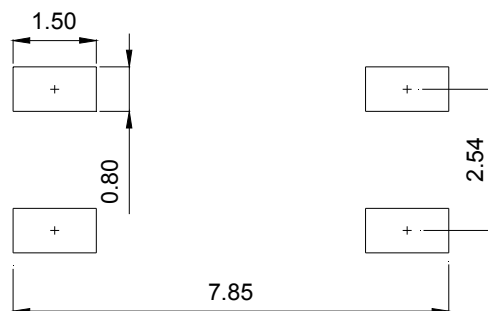
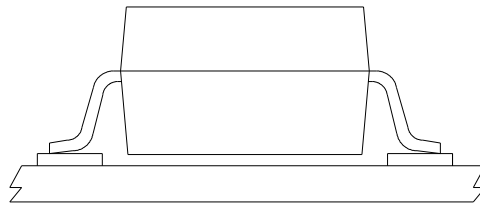
Notes :

KTLP260J = Part No.

X = Tape and reel option (TLD 、 TRU)

| Option | Description | Packing quantity |
|--------|---|---------------------|
| TLD | surface mount type package + TLD tape & reel option | 3000 units per reel |
| TRU | surface mount type package + TRU tape & reel option | 3000 units per reel |

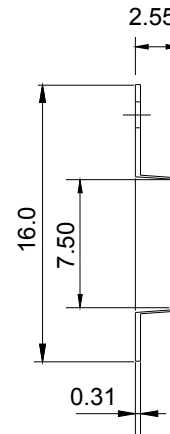
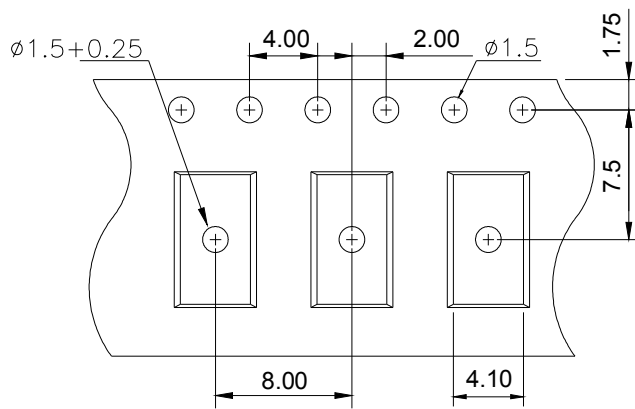
- **Recommended Pad Layout for Surface Mount Lead Form**



Unit : mm

● 4-pin Mini-Flat TLD/TRU Carrier Tape & Reel

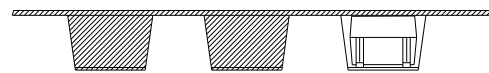
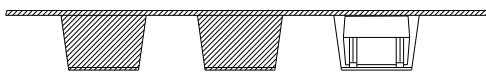
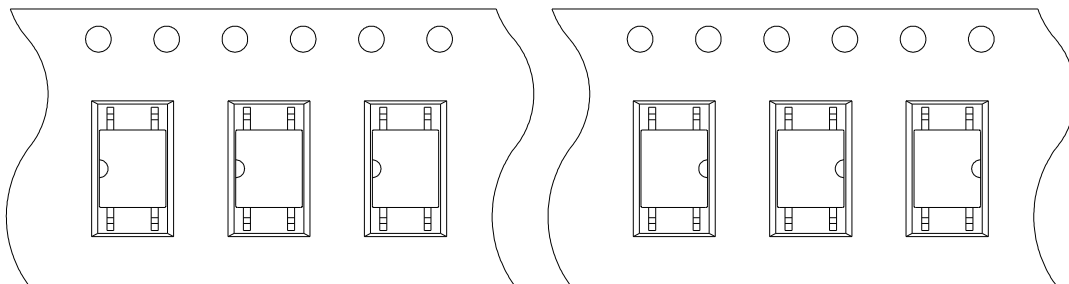
Unit : mm



TOLERANCE : $\pm 0.2\text{mm}$

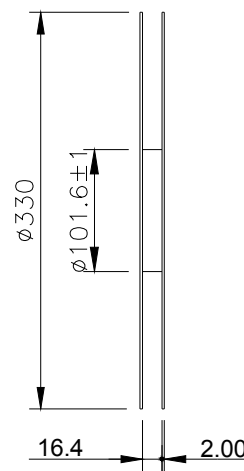
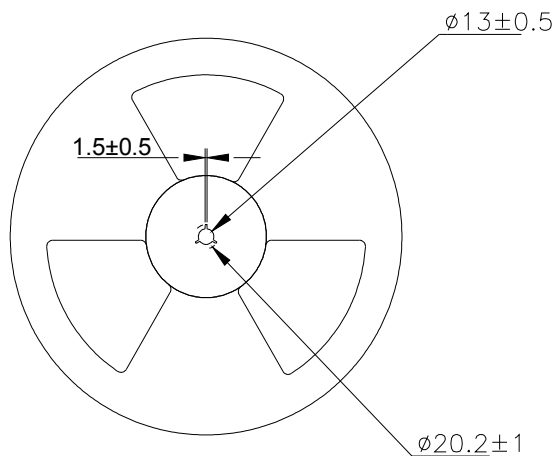
TLD

TRU



Direction of feed from reel

Direction of feed from reel





KTLP260J Series

4PIN MINI-FLAT RANDOM-PHASE TRIAC DRIVER PHOTOCOUPLER

● Application Notice

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- h. Telecommunication

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